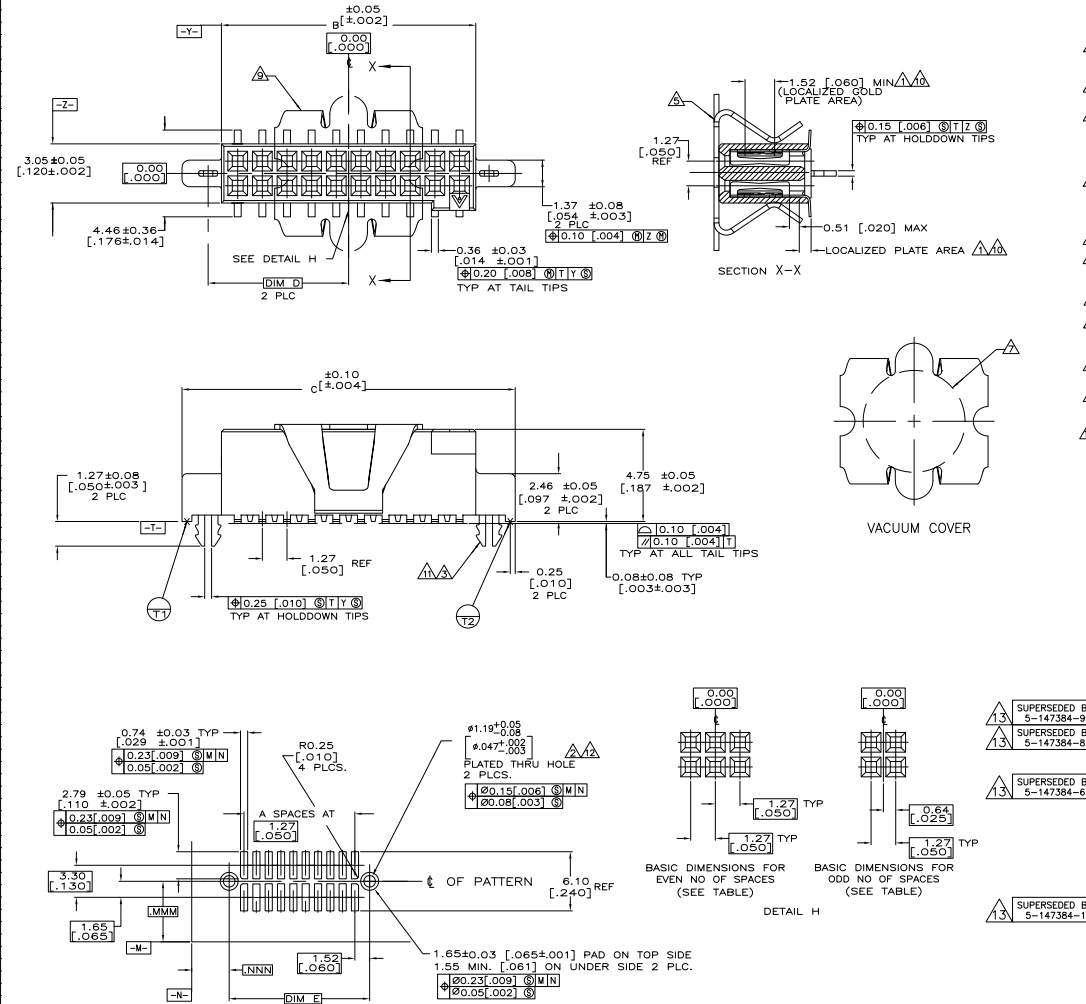


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REV	DATE	DESCRIPTION	BY	CHK	APP
AD	00	REVISED PER EDD-11-004917	11MM11	RK	HMR



- △ 0.00076 [0.00030] GOLD IN LOCALIZED PLATE AREA
0.00381 [0.00150] TIN-LEAD ON SOLDER TAILS ALL OVER 0.00127 [0.00050] NICKEL
- △ USE 1.55±0.02 [0.061±0.010] DRILLED HOLE (1.55mm DRILL) FINISH TO BE TIN/LEAD OVER 0.02 [0.001] MIN COPPER
- △ PLATING: 0.0038 [0.00150] TIN-LEAD OVER 0.00127 [0.00050] NICKEL
- 4. IF PLANNING TO USE MORE THAN ONE MATING PAIR OF CONNECTORS TO INTERCONNECT 2 BOARDS, PLEASE REFER TO PARA. 3.3 IN THE APPLICATION SPEC. #114-7010
- △ VACUUM COVER DESIGNED FOR 4.0 [160] DIA NOZZLE. VACUUM COVER TO BE REMOVED AFTER SOLDERING.
- 6. PACKAGED IN EIA 481 TAPE AND REEL. SEE TABLE FOR TAPE WIDTHS.
- △ 5.2 [0.205] MIN TARGET AREA FOR VACUUM PICK-UP.
- △ HOUSING: LCP, COLOR-BLACK, CONTACT: COPPER ALLOY PER ASTM SPECIFICATION B422. HOLD-DOWN: COPPER ALLOY PER ASTM SPECIFICATION B194. VACUUM COVER: ALUMINUM ALLOY PER ASTM SPECIFICATION B209.
- △ VACUUM COVER SHOWN IN PHANTOM LINE.
- △ 0.00076 [0.00030] GOLD IN LOCALIZED PLATE AREA
0.00381 [0.00150] TIN ON SOLDER TAILS ALL OVER 0.00127 [0.00050] NICKEL
- △ PLATING: 0.0038 [0.00150] TIN OVER 0.00127 [0.00050] NICKEL
- △ USE 1.55±0.02 [0.061±0.010] DRILLED HOLE (1.55mm DRILL) FINISH TO BE TIN OVER 0.02 [0.001] MIN COPPER
- △ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI

FINISH	TAPE WIDTH	E	D	C	B	A	NO OF POS	PART NUMBER
△	88 mm	65.28 [2.570]	32.64 [1.285]	67.97 [2.676]	63.91 [2.516]	49	100	5-147384-9
△	72 mm	52.58 [2.070]	26.29 [1.035]	55.27 [2.176]	51.21 [2.016]	39	80	5-147384-8
△	72 mm	46.23 [1.820]	23.11 [0.910]	48.92 [1.926]	44.86 [1.766]	34	70	5-147384-7
△	72 mm	39.88 [1.570]	19.94 [0.785]	42.57 [1.676]	38.51 [1.516]	29	60	5-147384-6
△	56 mm	33.53 [1.320]	16.76 [0.660]	36.22 [1.426]	32.16 [1.266]	24	50	5-147384-5
△	56 mm	27.18 [1.070]	13.59 [0.535]	29.87 [1.176]	25.81 [1.016]	19	40	5-147384-4
△	44 mm	20.83 [0.820]	10.41 [0.410]	23.52 [0.926]	19.46 [0.766]	14	30	5-147384-3
△	32 mm	14.48 [0.570]	7.24 [0.285]	17.17 [0.676]	13.11 [0.516]	9	20	5-147384-2
△	32 mm	8.12 [0.320]	4.06 [0.160]	10.82 [0.426]	6.75 [0.266]	4	10	5-147384-1

- △ SUPERSEDED BY 5-147384-9
- △ SUPERSEDED BY 5-147384-8
- △ SUPERSEDED BY 5-147384-6
- △ SUPERSEDED BY 5-147384-1

RECOMMENDED BOARD LAYOUT
 SCALE: 5:1

THIS DRAWING IS A CONTROLLED DOCUMENT. INVENTOR: [NAME] CHECKED: [NAME] DATE: [DATE] DESIGNED: [NAME] DATE: [DATE] DRAWN: [NAME] DATE: [DATE]

TE Connectivity
 ASSEMBLY, RECEPTACLE, VERTICAL DOUBLE ROW, SURFACE MOUNT, AMPMODU 50/50 GRID CONNECTOR

SIZE: 108-1332
 DATE: 114-7010
 PART: 00779G=147384